



ES2A/A - ES2D/A

2.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features

- **Glass Passivated Die Construction**
- Super-Fast Recovery Time For High Efficiency
- Surge Overload Rating to 50A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See Page 3
- Ordering Information: See Page 3
- SMA Weight: 0.064 grams (approximate)
- SMB Weight: 0.093 grams (approximate)



Top View

Bottom View

Maximum Ratings @TA = 25° C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

| For capacitance load, derate current by 20%. | | | | | | |
|---|--|--------|--------|--------|--------|------|
| Characteristic | Symbol | ES2A/A | ES2B/A | ES2C/A | ES2D/A | Unit |
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 6) | V _{RRM} V _{RWM} VR | 50 | 100 | 150 | 200 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 35 | 70 | 105 | 140 | V |
| Average Rectified Output Current @ T _T = 110°C | lo | | 2 | .0 | | Α |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single half Sine-Wave Superimposed on Rated Load | I _{FSM} | | 5 | 0 | | А |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|----------------------------------|-------------|------|
| Typical Thermal Resistance, Junction to Terminal (Note 3) | $R_{\theta JT}$ | 20 | °C/W |
| Operating and Storage Temperature Range | T _{J,} T _{STG} | -55 to +150 | °C |

Electrical Characteristics @T_A = 25°C unless oth erwise specified

| Characteristic | | Symbol | Value | Unit |
|---|---|-----------------|------------|------|
| Forward Voltage | @ I _F = 2.0A | V _{FM} | 0.92 | V |
| Peak Reverse Current at Rated DC Blocking Voltage (Note 6) | @ T _A = 25°C @ T _A = 125°C | | 5.0 350 | μΑ |
| Typical Total Capacitance (Note 4) | | CT | 25 | pF |
| Reverse Recovery Time (Note 5) | | t _{rr} | 25 | ns |

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/quality/lead_free.html.

Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.

4. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

5. Measured with $I_F = 0.5A$, $I_{FF} = 1.0A$, $I_{rr} = 0.25A$. See Figure 5. 6. Short duration pulse test used to minimize self-heating effect.



ES2A/A - ES2D/A

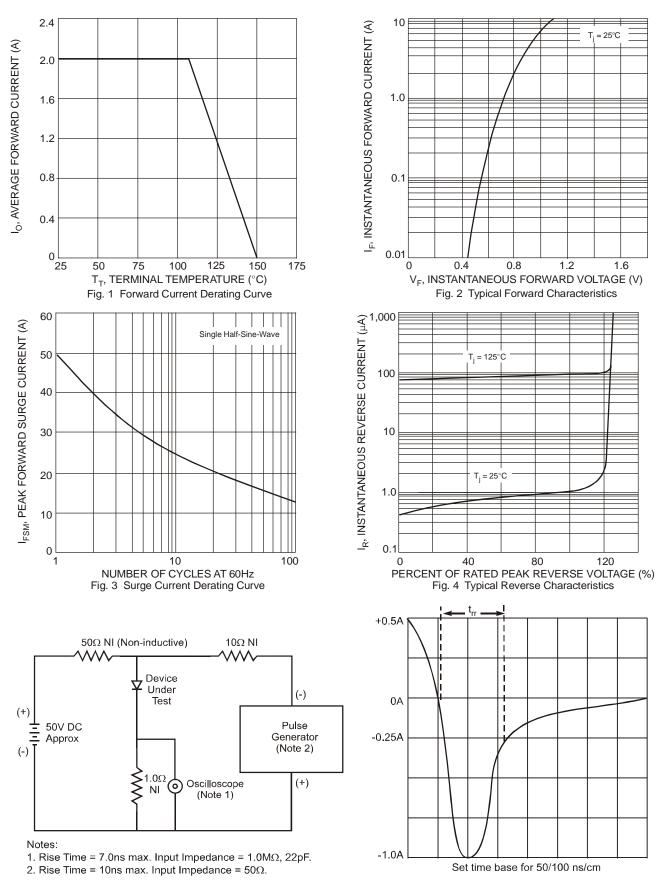


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



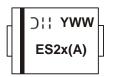
Ordering Information (Note 7)

| Part Number | Case | Packaging |
|-------------|------|------------------|
| ES2xA-13-F | SMA | 5000/Tape & Reel |
| ES2x-13-F | SMB | 3000/Tape & Reel |

* x = Device type, e.g. ES2BA-13-F (SMA package); ES2A-13-F (SMB package).

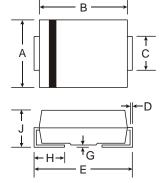
Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



ES2XA = Product type marking code, ex: ES2BA (SMA package) ES2X = Product type marking code, ex: ES2A (SMB package) CH = Manufacturers' code marking YWW = Date code marking Y = Last digit of year (ex: 2 for 2002) WW = Week code 01 to 52

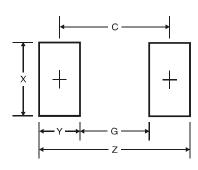
Package Outline Dimensions



| SMA | | |
|----------------------|------|------|
| Dim | Min | Max |
| Α | 2.29 | 2.92 |
| В | 4.00 | 4.60 |
| С | 1.27 | 1.63 |
| D | 0.15 | 0.31 |
| E | 4.80 | 5.59 |
| G | 0.05 | 0.20 |
| Н | 0.76 | 1.52 |
| J | 2.01 | 2.30 |
| All Dimensions in mm | | |

| SMB | | | |
|----------------------|------|------|--|
| Dim | Min | Max | |
| Α | 3.30 | 3.94 | |
| В | 4.06 | 4.57 | |
| С | 1.96 | 2.21 | |
| D | 0.15 | 0.31 | |
| Е | 5.00 | 5.59 | |
| G | 0.05 | 0.20 | |
| Н | 0.76 | 1.52 | |
| J | 2.00 | 2.62 | |
| All Dimensions in mm | | | |

Suggested Pad Layout



| SMA Dimensions | Value (in mm) |
|-------------------|---------------|
| Z | 6.5 |
| G | 1.5 |
| Х | 1.7 |
| Y | 2.5 |
| С | 4.0 |

| SMB Dimensions | Value (in mm) |
|-------------------|---------------|
| Z | 6.7 |
| G | 1.8 |
| Х | 2.3 |
| Y | 2.5 |
| С | 4.3 |



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